

VSTA065R58ANA

Datasheet



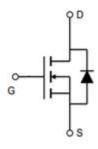


VSTA065R58ANA

General Description

V _{(BR)DSS}	R _{DS(ON)_max}	I_D
650V	580mΩ@10V	8A

Symbol



Symbol of VSTA065R58ANA

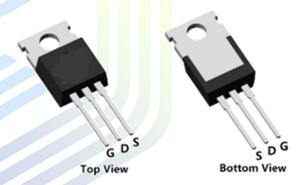
Features

- $V_{DS} = 650V, I_D = 8A$
- $\blacksquare R_{DS(ON) max} = 580 \text{m}\Omega @V_{GS} = 10V$
- Extremely low switching loss
- Excellent stability and uniformity
- RoHS and Halogen-Free Compliant

Application

- PC power
- LED lighting
- Telecom power
- Server power
- Solar/UPS

Package Type



Package Type of VSTA065R58ANA

Ordering Information

Product Name	Package	Marking		
VSTA065R58ANA	TO-220	STA065R58ANA		



VSTA065R58ANA

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	650	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current Note 1, T _C =25°C	I_D	8	A
Pulsed Drain Current Note 2, T _C =25°C	I _{D, pulse}	24	A
Continuous Diode Forward Current Note 1, T _C =25°C	I_S	8	A
Diode Pulsed Current Note 2, T _C =25°C	I _{S, pulse}	24	A
Max Power Dissipation Note 3, T _C =25°C	P_{D}	110	W
Avalanche Current, Single Pulse Note 4	I _{AS}	6	A
Avalanche Energy, Single Pulse Note4	Eas	195	mJ
MOSFET dv/dt ruggedness, V _{DS} =0~480V	dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} =0~480V, I _{SD} <= I _D	dv/dt	15	V/ns
Operation and storage temperature	T _J ,T _{STG}	-55 to 150	°C

Thermal Resistance

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		1.14		°C/W
Thermal Resistance, Junction-to-Ambient Note5	$R_{ heta JA}$		62		C/W

Notes:

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4: V_{DD} =50V, V_{GS} =10V, L=10.8mH, starting T_A =25 °C.

Note5: When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.



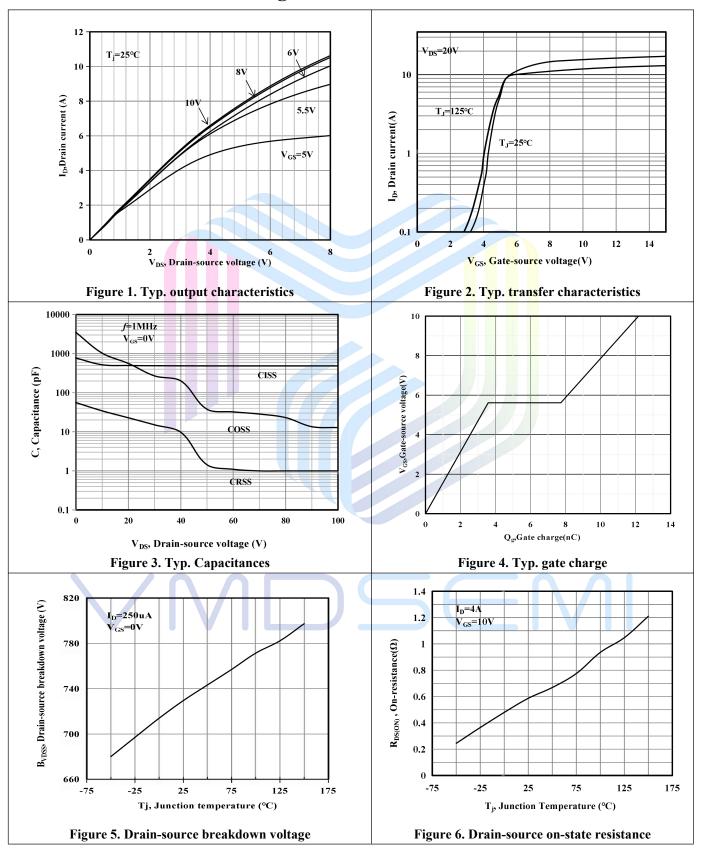
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Electrical Characteristics (T_A= 25 °C, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Тур	Max	Unit
Statistic Characteristics							
Drain-Source Breakdown Voltage		BV_{DSS}	V _{GS} =0V, I _D =250uA	650			V
Drain-Source Leakage Current		I_{DSS}	V _{DS} =650V, V _{GS} =0V			1	uA
Gate-Source Leakage Current	Forward	I _{GSSF}	V _{GS} =30V, V _{DS} =0V			100	nA
	Reverse	I_{GSSR}	V_{GS} =-30V, V_{DS} =0V			-100	
Gate Threshold Voltage		$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250uA	2		4	V
Drain-Source On-State Resistan	ce	R _{DS(ON)}	$V_{GS}=10V, I_{D}=4A$		535	580	mΩ
Gate Resistance		R_G	F=1MHz, Open Drain		3.7		Ω
Dynamic Characteristics							
Input Capacitance		C _{iss}	N CONN ON		485		pF
Output Capacitance		Coss	$V_{DS}=50V, V_{GS}=0V,$		37.8		pF
Reverse Transfer Capacitance		C_{rss}	f=1MHz		1.43		pF
Turn-on Delay Time		t _{d(on)}			11.4		
Rise Time		$t_{\rm r}$	V_{DS} =380V, I_{D} =8A,		9.1		ns
Turn-off Delay Time		t _{d(off)}	$R_G=25\Omega$, $V_{GS}=10V$		40.8		
Fall Time		t_{f}			7.6		
Gate Charge Characteristics							
Gate to Source Charge		Q_{gs}			3.18		
Gate to Drain Charge		Q_{gd}	V_{DS} =480V, I_{D} =8A,		4.79		nC
Gate Charge Total		Qg	V _{GS} =0 to 10V		12.37		
Gate Plateau Voltage		V _{Plateau}			5.61		V
Reverse Diode Characteristics				•			
Drain-Source Diode Forward Voltage		V_{SD}	$V_{GS}=0V$, $I_{S}=1A$		0.76		V
Reverse Recovery Time		t _{rr}	V _R =480V, I _S =8A, di/dt=100A/us		223		ns
Reverse Recovery Charge		Qrr			2.06		uС
Peak Reverse Recovery Current		I _{rrm}			16.13		A



Electrical Characteristics Diagrams





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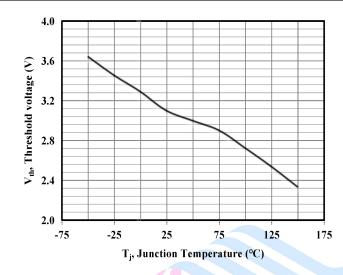


Figure 7. Threshold voltage

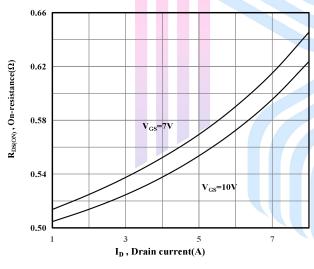


Figure 9. Drain-source on-state resistance

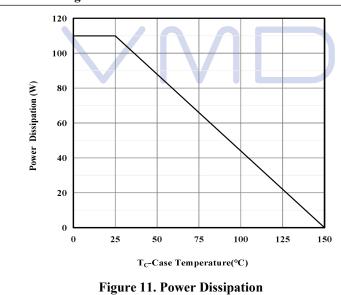


Figure 8. Forward characteristic of body diode

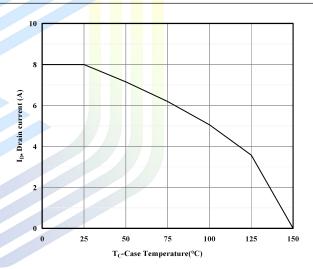


Figure 10. Drain current Derating

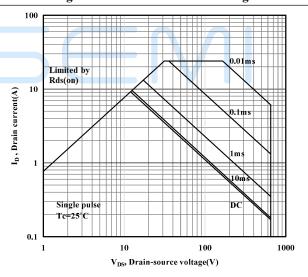
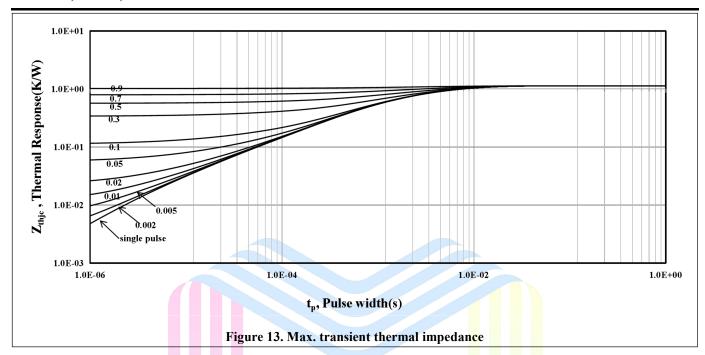


Figure 12. Safe operation area T_C=25 °C



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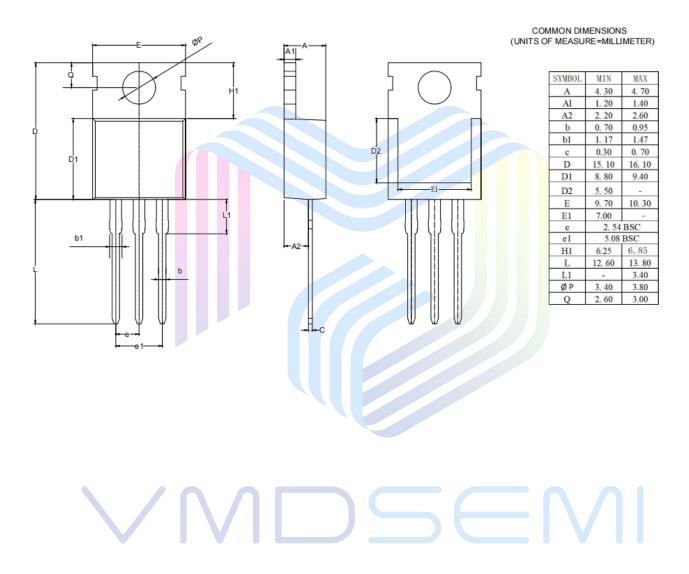






Mechanical Dimensions

TO-220 Package Information



580mΩ, 650V, N-Channel Power MOSFET

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